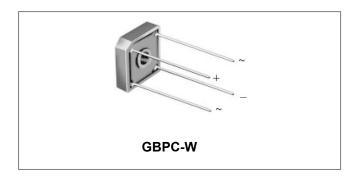


GBPC35005W THRU GBPC3510W

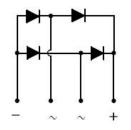
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GBPC35005W THRU GBPC3510W SINGLE PHASE 35 AMP GLASS PASSIVATED BRIDGE RECTIFIER



Circuit Diagram



Features

- Glass passivated die construction
- Low forward voltage drop
- High current capability
- High surge current capability
- Plastic material-UL flammability 94V-0
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Mechanical Data

- Case: GBPC-W, molded plastic
- Terminals: plated leads solderable per MIL-STD-202, Method 208
- Polarity: as marked on case
- Mounting position: Any
- Lead Free: For RoHS / Lead Free Version

Maximum Ratings: @T_A=25°C unless otherwise specified

Single Phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Type number	Symbol	GBPC 35005W	GBPC 3501W	GBPC 3502W	GBPC 3504W	GBPC 3506W	GBPC 3508W	GBPC 3510W	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM}	50	100	200	400	600	800	1000	V
RMS Reverse Voltage	VRMS	35	70	140	280	420	560	700	V
Average Rectified Output Current (Note 1) @ T_A =55 °C	l _o				35				А
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}				400				А



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RoHS 🛛

Electrical Characteristics:@T_A=25°C unless otherwise specified

Type number	Symbol	GBPC 35005W	GBPC 3501W	GBPC 3502W	GBPC 3504W	GBPC 3506W	GBPC 3508W	GBPC 3510W	Units
Forward Voltage per element @I⊧=17.5A	VF	1.1					V		
Peak Reverse Current @T _A =25°C At Rated DC Blocking Voltage @T _A =125°C	I _R				5 500				μA
Typical Junction Capacitance (Note 2)	CJ				300				pF

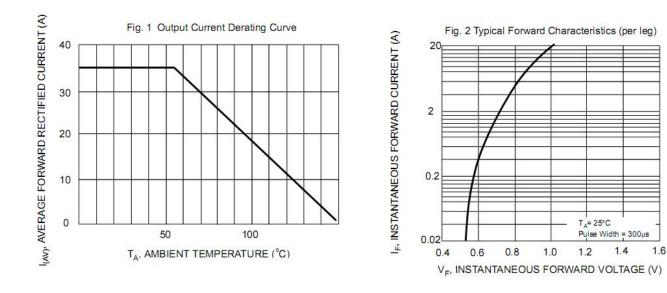
* Pulse width < 300 µs, duty cycle < 2%

Thermal-Mechanical Specifications:@T_A=25°C unless otherwise specified

Type number	Symbol	GBPC 35005W	GBPC 3501W	GBPC 3502W	GBPC 3504W	GBPC 3506W	GBPC 3508W	GBPC 3510W	Units
Typical Thermal Resistance Junction to Lead	$R_{\theta JL}$	2.2							
Junction Temperature	TJ	-55 to +150			°C				
Storage Temperature Range	T _{STG}			-55	5 to +150				°C

Note: 1. Mounted on glass epoxy PC board with 1.3mm² solder pad. 2.Measured at 1.0 MHz and applied reverse voltage of 4.0V D.C.

Ratings and Characteristics Curves



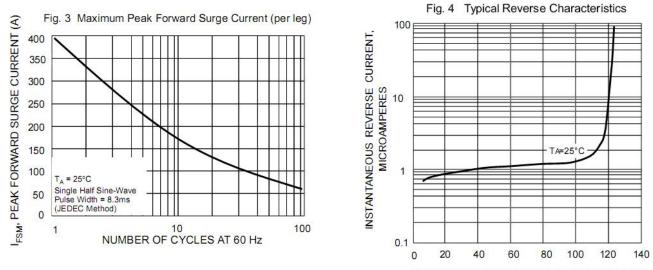
China - Germany - Korea - Singapore - United States http://www.smc-diodes.com - sales@ smc-diodes.com -



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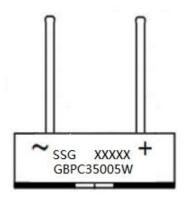
PERCENT OF RATED PEAK REVERSE VOLTAGE (%)

Ordering Information

Device	Package	Plating	Shipping		
GBPC35005W-GBPC3510W	GBPC-W(Pb-Free)	Pure Sn	50pcs / box		

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

Marking Diagram



Where XXXXX is YYWWL

SSG	= SSG
YY	= Year
WW	= Week
L	= Lot Number
GBPC35005W	= Type Number

Cautions: Molding resin Epoxy resin UL:94V-0

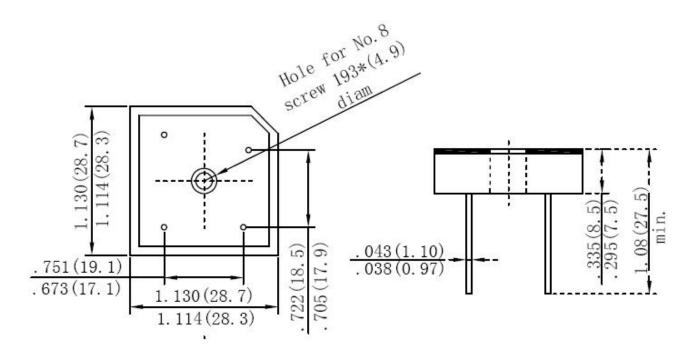


GBPC35005W THRU GBPC3510W

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Mechanical Dimensions GBPC-W (Inches/Millimeters)





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